

# STB28NM60ND, STF28NM60ND, life.augmented STP28NM60ND, STW28NM60ND

N-channel 600 V, 0.13 Ω typ., 23 A FDmesh™ II Power MOSFETs in D2PAK, TO-220FP, TO-220 and TO-247 packages

Datasheet - production data

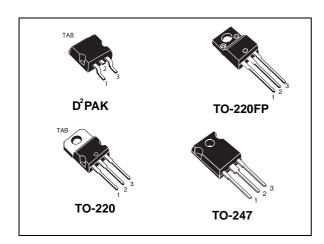
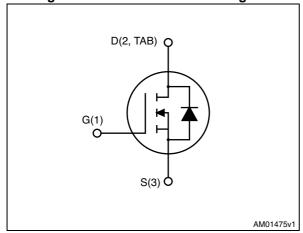


Figure 1. Internal schematic diagram



#### **Features**

Order codes	V <sub>DS @</sub> T <sub>J max.</sub>	R <sub>DS(on) max</sub>	I <sub>D</sub>
STB28NM60ND			
STF28NM60ND	CEO.V	0.450.0	00.4
STP28NM60ND	650 V	0.150 Ω	23 A
STW28NM60ND			

- Intrinsic fast-recovery body diode
- 100% avalanche tested
- Low input capacitance and gate charge
- Low gate input resistance
- Extremely high dv/dt and avalanche capabilities

#### **Applications**

Switching applications

## **Description**

These FDmesh™ II Power MOSFETs with intrinsic fast-recovery body diode are produced using the second generation of MDmesh™ technology. Utilizing a new strip-layout vertical structure, these revolutionary devices feature extremely low on-resistance and superior switching performance. They are ideal for bridge topologies and ZVS phase-shift converters.

**Table 1. Device summary** 

Order codes	Marking	Packages	Packaging
STB28NM60ND		D <sup>2</sup> PAK	Tape and reel
STF28NM60ND	28NM60ND -	TO-220FP	
STP28NM60ND		TO-220	Tube
STW28NM60ND		TO-247	

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## 1 Electrical ratings

Table 2. Absolute maximum ratings

		Value	)		
Symbol	Parameter	D <sup>2</sup> PAK, TO-220, TO-247	TO-220FP	Unit	
$V_{DS}$	Drain-source voltage	600		V	
V <sub>GS</sub>	Gate-source voltage	±25		V	
I <sub>D</sub>	I <sub>D</sub> Drain current (continuous) at T <sub>C</sub> = 25 °C 23		23 <sup>(1)</sup>	Α	
I <sub>D</sub>	Drain current (continuous) at T <sub>C</sub> = 100 °C	14.5	14.5 <sup>(1)</sup>	Α	
I <sub>DM</sub> <sup>(2)</sup>	Drain current (pulsed)	92	92(1)	Α	
P <sub>TOT</sub>	Total dissipation at T <sub>C</sub> = 25 °C	190	35	W	
dv/dt <sup>(3)</sup>	Peak diode recovery voltage slope	40		V/ns	
V <sub>ISO</sub>	Insulation withstand voltage (RMS) from all three leads to external heat sink (t=1 s; T <sub>C</sub> =25 °C)	m 2500		V	
T <sub>stg</sub>	Storage temperature	-55 to 150		°C	
TJ	Max. operating junction temperature	150		°C	

- 1. Limited by maximum junction temperature
- 2. Pulse width limited by safe operating area
- 3.  $I_{SD} \le 23 \text{ A}, \text{ di/dt } \le 600 \text{ A/}\mu\text{s}, V_{DD} = 80\% V_{(BR)DSS}$

Table 3. Thermal data

Symbol	Parameter	D <sup>2</sup> PAK	TO-220FP	TO-220	TO-247	Unit
R <sub>thj-case</sub>	Thermal resistance junction-case max	0.66	3.6	0.	66	°C/W
R <sub>thj-amb</sub>	Thermal resistance junction-ambient max		62.5		50	°C/W
R <sub>thj-pcb</sub> <sup>(1)</sup>	Thermal resistance junction-pcb max	30				°C/W

<sup>1.</sup> When mounted on 1inch² FR-4 board, 2 oz Cu

**Table 4. Avalanche characteristics** 

Symbol	Parameter	Max value	Unit
I <sub>AR</sub>	Avalanche current, repetitive or not-repetitive (pulse width limited by T <sub>J</sub> max)	5	Α
E <sub>AS</sub>	Single pulse avalanche energy (starting $T_J = 25$ °C, $I_D = I_{AS}$ , $V_{DD} = 50$ V)	450	mJ



### 2 Electrical characteristics

(T<sub>CASE</sub>=25 °C unless otherwise specified).

Table 5. On/off states

Symbol	Parameter	Test conditions	Value			Unit
Symbol	Farameter	rest conditions	Min.	Тур.	Max.	Onit
V <sub>(BR)DSS</sub>	Drain-source breakdown voltage	I <sub>D</sub> = 1 mA, V <sub>GS</sub> = 0	600			V
dv/dt <sup>(1)</sup>	Drain source voltage slope	V <sub>DD</sub> = 480 V, I <sub>D</sub> = 23 A, V <sub>GS</sub> = 10 V		45		V/ns
lana	Zero gate voltage	V <sub>DS</sub> = 600 V			1	μΑ
I <sub>DSS</sub>	drain current (V <sub>GS</sub> = 0)	$V_{DS} = 600 \text{ V}, T_{C} = 125 ^{\circ}\text{C}$			100	μΑ
I <sub>GSS</sub>	Gate-body leakage current (V <sub>DS</sub> = 0)	V <sub>GS</sub> = ± 20 V			±100	nA
V <sub>GS(th)</sub>	Gate threshold voltage	$V_{DS} = V_{GS}, I_{D} = 250 \mu A$	3	4	5	V
R <sub>DS(on)</sub>	Static drain-source on resistance	V <sub>GS</sub> = 10 V, I <sub>D</sub> = 11.5 A		0.13	0.15	Ω

<sup>1.</sup> Characteristic value at turn off on inductive load.

Table 6. Dynamic

Symbol	Parameter	Test conditions	Min.	Тур.	Max.	Unit
C <sub>iss</sub>	Input capacitance		-	2090	-	pF
C <sub>oss</sub>	Output capacitance	V <sub>DS</sub> = 100 V, f = 1 MHz,	-	90	-	pF
C <sub>rss</sub>	Reverse transfer capacitance	V <sub>GS</sub> = 0	-	5.5	-	pF
C <sub>oss eq.</sub> <sup>(1)</sup>	Equivalent output capacitance	$V_{GS} = 0$ , $V_{DS} = 0$ to 480 V	-	312	-	pF
t <sub>d(on)</sub>	Turn-on delay time	V <sub>DD</sub> = 300 V, I <sub>D</sub> = 11.5 A	-	23.5	-	ns
t <sub>r</sub>	Rise time	$R_G = 4.7 \Omega V_{GS} = 10 V$	-	21.5	-	ns
t <sub>d(off)</sub>	Turn-off delay time	(see Figure 18),	-	92	-	ns
t <sub>f</sub>	Fall time	(see Figure 20)	-	27	-	ns
$Q_g$	Total gate charge	V <sub>DD</sub> = 480 V, I <sub>D</sub> = 23 A,	-	62.5	-	nC
Q <sub>gs</sub>	Gate-source charge	V <sub>GS</sub> = 10 V, (see Figure 10)	-	11	-	nC
Q <sub>gd</sub>	Gate-drain charge		-	38	-	nC
R <sub>g</sub>	Gate input resistance	f = 1  MHz, test signal level = 20 mV, $I_D = 0$	-	4.7	-	Ω

<sup>1.</sup>  $C_{oss\ eq}$  is defined as a constant equivalent capacitance giving the same charging time as  $C_{oss}$  when  $V_{DS}$  increases from 0 to 80%  $V_{DSS}$ 

Table 7. Source drain diode

Symbol	Parameter	Test conditions	Min.	Тур.	Max.	Unit
I <sub>SD</sub>	Source-drain current		-		23	Α
I <sub>SDM</sub> <sup>(1)</sup>	Source-drain current (pulsed)		-		92	Α
V <sub>SD</sub> <sup>(2)</sup>	Forward on voltage	I <sub>SD</sub> = 23 A, V <sub>GS</sub> = 0	-		1.6	V
t <sub>rr</sub>	Reverse recovery time	I <sub>SD</sub> = 23 A, V <sub>DD</sub> = 60 V	-	170		ns
Q <sub>rr</sub>	Reverse recovery charge	di/dt=100 A/μs	-	1160		nC
I <sub>RRM</sub>	Reverse recovery current	(see Figure 17)	-	14		Α
t <sub>rr</sub>	Reverse recovery time	I <sub>SD</sub> = 23 A,V <sub>DD</sub> = 60 V	-	237		ns
Q <sub>rr</sub>	Reverse recovery charge	di/dt=100 A/µs, T <sub>.I</sub> = 150 °C	-	2090		nC
I <sub>RRM</sub>	Reverse recovery current	(see Figure 17)	-	18		Α

<sup>1.</sup> Pulse width limited by safe operating area

<sup>2.</sup> Pulsed: Pulse duration = 300  $\mu$ s, duty cycle 1.5%.

### 2.1 Electrical characteristics (curves)

Figure 2. Safe operating area for D<sup>2</sup>PAK and TO-220

Figure 3. Thermal impedance for D<sup>2</sup>PAK and TO-220

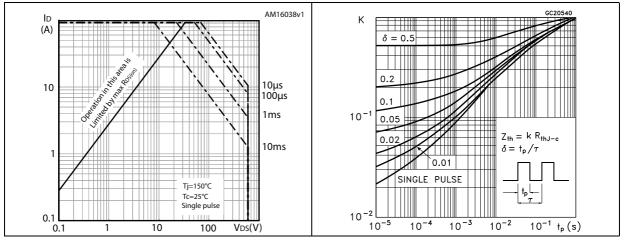


Figure 4. Safe operating area for TO-220FP

Figure 5. Thermal impedance for TO-220FP

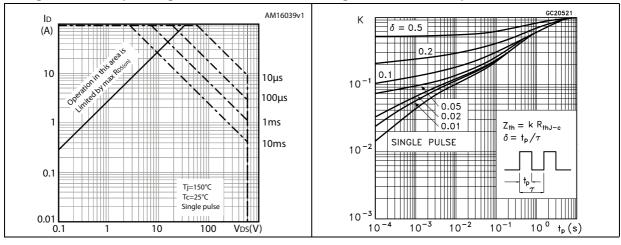
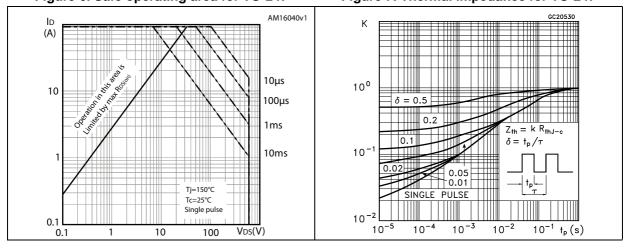


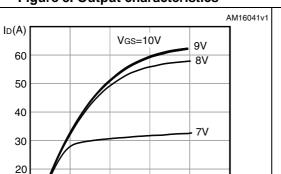
Figure 6. Safe operating area for TO-247

Figure 7. Thermal impedance for TO-247



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Figure 8. Output characteristics



15

6V

V<sub>DS</sub>(V)

Figure 9. Transfer characteristics

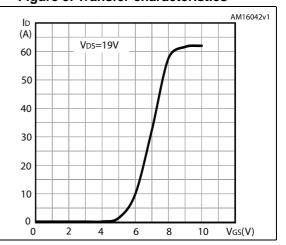


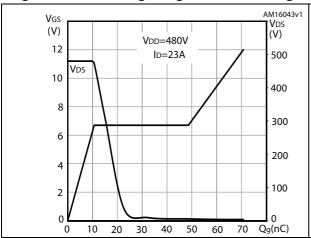
Figure 10. Gate charge vs gate-source voltage

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5

10

Figure 11. Static drain-source on-resistance



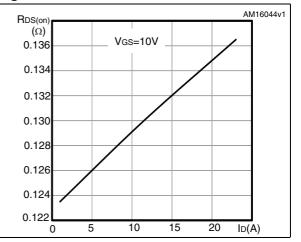
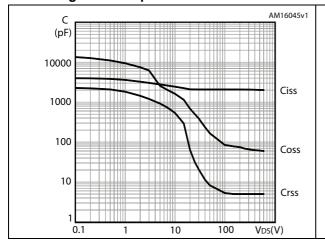
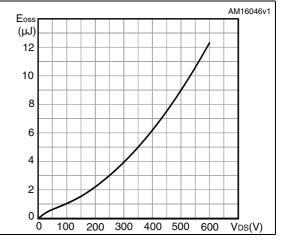


Figure 12. Capacitance variations

Figure 13. Output capacitance stored energy

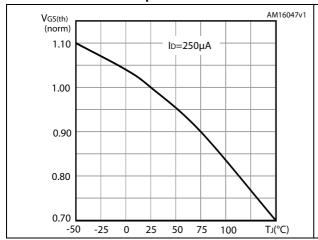




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Figure 14. Normalized gate threshold voltage vs temperature

Figure 15. Normalized on-resistance vs temperature



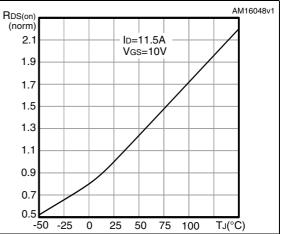
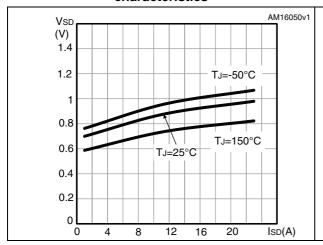
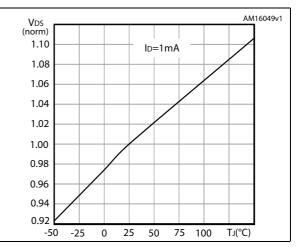


Figure 16. Source-drain diode forward characteristics

Figure 17. Normalized  $\rm V_{\rm DS}$  vs temperature





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### 3 Test circuits

Figure 18. Switching times test circuit for resistive load

Figure 19. Gate charge test circuit

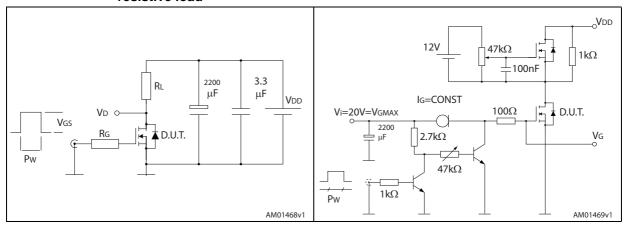


Figure 20. Test circuit for inductive load switching and diode recovery times

Figure 21. Unclamped inductive load test circuit

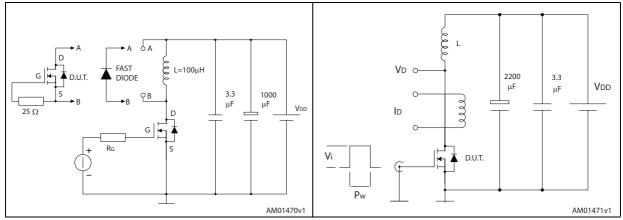
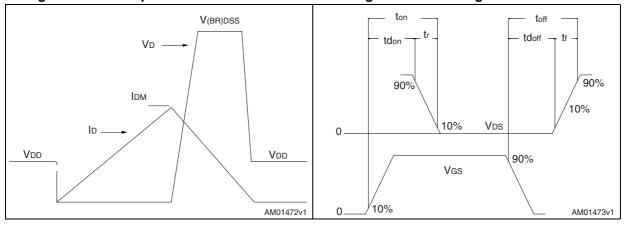


Figure 22. Unclamped inductive waveform

Figure 23. Switching time waveform



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# 4 Package mechanical data

In order to meet environmental requirements, ST offers these devices in different grades of ECOPACK<sup>®</sup> packages, depending on their level of environmental compliance. ECOPACK<sup>®</sup> specifications, grade definitions and product status are available at: <a href="https://www.st.com">www.st.com</a>. ECOPACK<sup>®</sup> is an ST trademark.

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# 4.1 D<sup>2</sup>PAK, STB28NM60ND

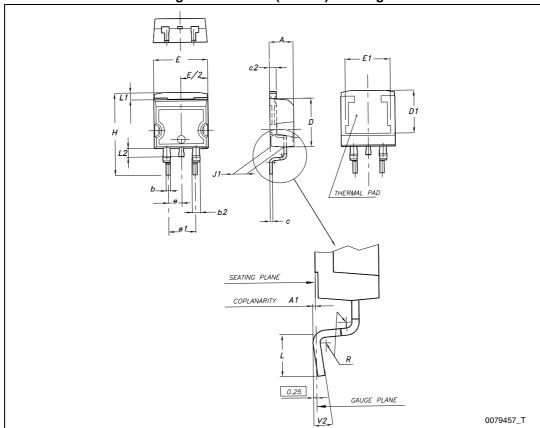
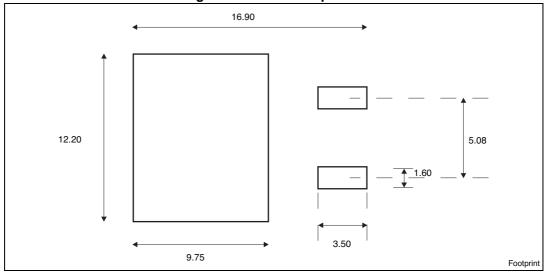


Figure 24. D<sup>2</sup>PAK (TO-263) drawing

Table 8. D<sup>2</sup>PAK (TO-263) mechanical data

Dim. mm			
Dilli.	Min.	Тур.	Max.
Α	4.40		4.60
A1	0.03		0.23
b	0.70		0.93
b2	1.14		1.70
С	0.45		0.60
c2	1.23		1.36
D	8.95		9.35
D1	7.50		
Е	10		10.40
E1	8.50		
е		2.54	
e1	4.88		5.28
Н	15		15.85
J1	2.49		2.69
L	2.29		2.79
L1	1.27		1.40
L2	1.30		1.75
R		0.4	
V2	0°		8°

Figure 25. D<sup>2</sup>PAK footprint<sup>(a)</sup>



a. All dimension are in millimeters

Ay)

#### 4.2 TO-220FP, STF28NM60ND

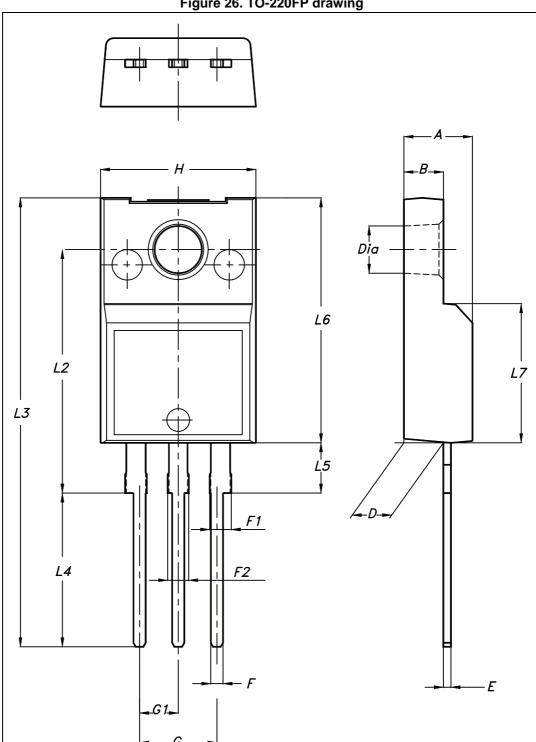


Figure 26. TO-220FP drawing

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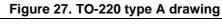
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Table 9. TO-220FP mechanical data

Dim		mm	
Dim.	Min.	Тур.	Max.
Α	4.4		4.6
В	2.5		2.7
D	2.5		2.75
E	0.45		0.7
F	0.75		1
F1	1.15		1.70
F2	1.15		1.70
G	4.95		5.2
G1	2.4		2.7
Н	10		10.4
L2		16	
L3	28.6		30.6
L4	9.8		10.6
L5	2.9		3.6
L6	15.9		16.4
L7	9		9.3
Dia	3		3.2

# 4.3 TO-220, STP28NM60ND



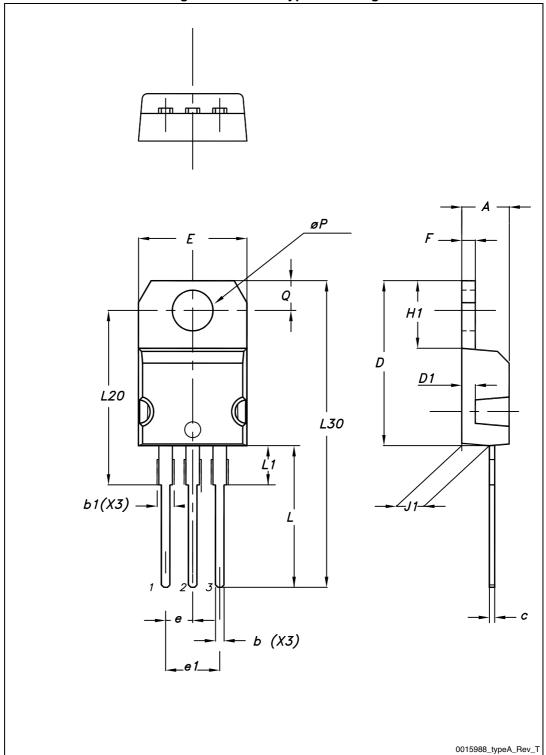


Table 10. TO-220 type A mechanical data

Dim		mm	
Dim.	Min.	Тур.	Max.
А	4.40		4.60
b	0.61		0.88
b1	1.14		1.70
С	0.48		0.70
D	15.25		15.75
D1		1.27	
E	10		10.40
е	2.40		2.70
e1	4.95		5.15
F	1.23		1.32
H1	6.20		6.60
J1	2.40		2.72
L	13		14
L1	3.50		3.93
L20		16.40	
L30		28.90	
ØP	3.75		3.85
Q	2.65		2.95

## 4.4 TO-247, STW28NM60ND

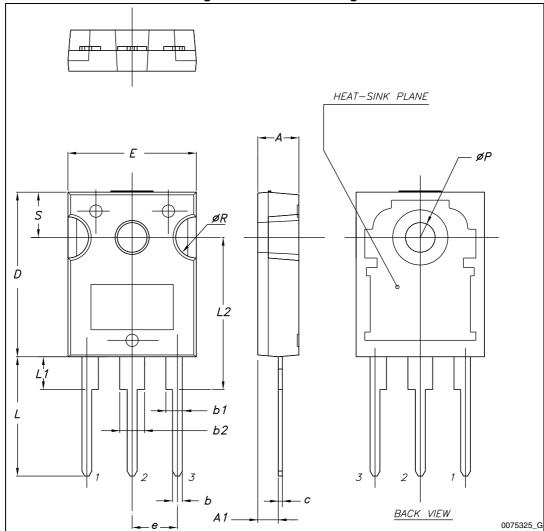


Figure 28. TO-247 drawing

Table 11. TO-247 mechanical data

Dim.	mm.				
	Min.	Тур.	Max.		
А	4.85		5.15		
A1	2.20		2.60		
b	1.0		1.40		
b1	2.0		2.40		
b2	3.0		3.40		
С	0.40		0.80		
D	19.85		20.15		
E	15.45		15.75		
е	5.30	5.45	5.60		
L	14.20		14.80		
L1	3.70		4.30		
L2		18.50			
ØP	3.55		3.65		
ØR	4.50		5.50		
S	5.30	5.50	5.70		

# 5 Packing mechanical data

10 pitches cumulative tolerance on tape +/- 0.2 mm
Top cover power tolerance on tape +/- 0.2 mm
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Top cover power

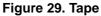
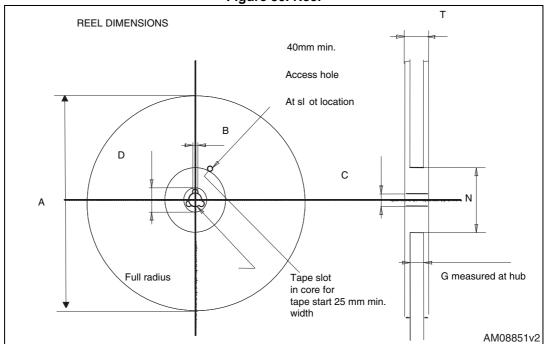


Table 12. D<sup>2</sup>PAK (TO-263) tape and reel mechanical data

Таре				Reel		
Dim.	n	nm	Dim.	mm		
	Min.	Max.		Min.	Max.	
A0	10.5	10.7	Α		330	
В0	15.7	15.9	В	1.5		
D	1.5	1.6	С	12.8	13.2	
D1	1.59	1.61	D	20.2		
Е	1.65	1.85	G	24.4	26.4	
F	11.4	11.6	N	100		
K0	4.8	5.0	Т		30.4	
P0	3.9	4.1				
P1	11.9	12.1		Base qty	1000	
P2	1.9	2.1		Bulk qty	1000	
R	50					
Т	0.25	0.35				
W	23.7	24.3				

Figure 30. Reel



# 6 Revision history

Table 13. Document revision history

Date	Revision	Changes	
15-Apr-2013	1	First release.	
25-Nov-2013	2	<ul> <li>Document status changed from preliminary to production data</li> <li>Modified: typical values in <i>Table 6</i> and 7</li> <li>Added: Section 2.1: Electrical characteristics (curves)</li> <li>Updated: <i>Table 10</i> and <i>Figure 27</i></li> <li>Minor text changes</li> </ul>	
05-May-2014	3	<ul><li>Modified: E<sub>AS</sub> value in <i>Table 4</i></li><li>Minor text changes</li></ul>	

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